SECURITIES AND EXCHANGE COMMISSION

WASHINGTON, D.C. 20549

FORM 8-K

CURRENT REPORT Pursuant to Section 13 or 15(d)

of the Securities Exchange Act of 1934

Date of Report (Date of earliest event reported): September 8, 2017

DIODES INCORPORATED

(Exact name of Registrant as Specified in Its Charter)

Delaware (State or Other Jurisdiction of Incorporation) 002-25577 (Commission File Number) 95-2039518 (IRS Employer Identification No.)

75024

(Zip Code)

4949 Hedgcoxe Road, Suite 200, Plano, TX

(Address of Principal Executive Offices)

Registrant's Telephone Number, Including Area Code: (972) 987-3900

Not Applicable

(Former Name or Former Address, if Changed Since Last Report)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions (see General Instructions A.2. below):

□ Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)

□ Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)

Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))

Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c)) Indicate by check mark whether the registrant is an emerging growth company as defined in Rule 405 of the Securities Act of 1933 (§230.405 of this chapter) or Rule 12b-2 of the Securities Exchange Act of 1934 (§240.12b-2 of this chapter).

Emerging growth company $\ \square$

If an emerging growth company, indicate by check mark if the registrant has elected not to use the extended transition period for complying with any new or revised financial accounting standards provided pursuant to Section 13(a) of the Exchange Act.

Item 8.01 Other Events.

From time to time, Diodes Incorporated (the "Company") may give corporate presentations to its customers, suppliers and other related interested parties. Copies of the Company's corporate presentation slides, updated on September 8, 2017, are attached herewith as Exhibit 99.1 and Exhibit 99.2.

Item 9.01 Financial Statements and Exhibits.

(d) Exhibits.

Exhibit
NumberDescription99.1Corporate Presentation Slides99.2Corporate Presentation Slides

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the Registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

Dated: September 8, 2017

DIODES INCORPORATED

By <u>/s/ Richard D. White</u> RICHARD D. WHITE Chief Financial Officer

Index to Exhibits

Exhibit	
Number	

 Number
 Description

 99.1
 Corporate Presentation Slides

 00.2
 Corporate Description

99.2 <u>Corporate Presentation Slides</u>



Diodes Incorporated Corporate Direction

www.diodes.com

DYODES



Shifting Gears to Profitability Growth

Mission: Profitability growth to expand shareholder value

Strategy: Grow revenue to \$2.5B at 40% GPM

Goal: \$1B Gross Profit by 2025





Busine	ss Model			
NR GP%	2017 \$1B 35%	→ →	2025 2.5B 40%	
GPM	\$350M	\rightarrow	\$1B	
R&D%	5%	\rightarrow	7%	ATTOLDER ALTOLDER
SG&A%	15%	\rightarrow	13%	-2-2402
PFO	15%	\rightarrow	20%	
DECDES	DISCRETE ANALOG LOGIC MIXED-SIGNAL			www.diodes.com

Market Focus: Balanced Portfolio



Extensive Portfolio of Automotive Products



Industrial: Automation and Precision Controls

- Increasing IC content in embedded systems
- Switching and signal path for networked systems and automation
- Signal conditioning and timing for precision controls
- Motor controls, sensors and power management for smart meters





IoT Driving Power and Connectivity Requirements



Efficiency, Functionality and Control for Smart Phones

- Focus on signal integrity and higher data rates
- Proliferation of USB Type-CTM connectivity and power delivery
- Power regulation and protection for new features
- Advanced power solutions for quick charge protocols





Cloud Computing Accelerating Enterprise Market



- ReDriver support for USB connectivity
- Wide range of signal protocols: PCIe, SAS, SATA, GbE, USB
- MUX products for high capacity solid state storage
- Crystal oscillators for increasing clocking speeds



Technology Focus









- High performance 8" MOSFET trench technology
- Advanced Epi bipolar transistor processes
- Proprietary rectifier
- Rugged automotive grade **NMOS and PMOS**

Assembly/Test

- Compact QFN and DFN
- Power density PowerDI
- Chip scale packaging and plating capability
- Extensive multi-chip package technology



System Focus



Complete Platform Solutions: Notebooks





Summary

- Vision: Expand shareholder value
- Mission: Profitability growth to drive 20% PFO
- Next Strategic Goal: \$1B gross profit
- Strategy: \$2.5B revenue at 40% GPM

Tactics:

- Increased focus on Automotive and Industrial markets
- Investment for technology leadership in target products, fab processes, and advanced packaging
- Systems solutions to drive business expansion





Thank you





Investor Relations Presentation

September 2017



Safe Harbor Statement

Any statements set forth herein that are not historical facts are forward-looking statements that involve risks and uncertainties that could cause actual results to differ materially from those in the forward-looking statements. Such forward-looking statements include, but are not limited to, statements regarding updates to Diodes Incorporated's third quarter 2017 business outlook as of August 8, 2017, which include the following: expect revenue to range between \$270 million and \$290 million, or up 2.2 to 9.8 percent sequentially; expect GAAP and non-GAAP gross margin to be 34.5 percent, plus or minus 1 percent; non-GAAP operating expenses, which are GAAP operating expense adjusted for KFAB closure costs, retention costs, and amortization of acquisition-related intangible assets, are expected to be approximately 22.5 percent of revenue, plus or minus 1 percent; expect net interest expense to be approximately \$3.0 million; expect tax rate to be 30.0 percent, plus or minus 3 percent; shares used to calculate diluted EPS for the second quarter are anticipated to be approximately 50.3 million; purchase accounting adjustments for Pericom and previous acquisitions of \$3.1 million after tax are not included in these non-GAAP estimates; and other statements identified by words such as "estimates," "expects," "projects," "plans," "will" and similar expressions.

Potential risks and uncertainties include, but are not limited to, such factors as: the risk that such expectations may not be met: the risk that the expected benefits of acquisitions may not be realized or that integration of acquired businesses, such as Pericom, may not continue as rapidly as we anticipate; the risk that we may not be able to maintain our current growth strategy or continue to maintain our current performance, costs, and loadings in our manufacturing facilities; the risk that we may not be able to increase our automotive or other revenue and market share; risks of domestic and foreign operations, including excessive operation costs, labor shortages, higher tax rates, and our joint venture prospects; the risk that we may not continue our share repurchase program; the risks of cyclical downturns in the semiconductor industry and of change sin end-market demand or product mix that may affect gross margin or render inventory obsolete; the risk of unfavorable currency exchange rates; the risk that our future outlook or guidance may be incorrect; the risks of global economic weakness or instability in global financial markets; the risks of trade restrictions, tariffs, or embargoes; the risk of breaches of our information technology systems; and other information, including the "Risk Factors" detailed from time to time in Diodes' filings with the United States Securities and Exchange Commission.

This presentation also contains non-GAAP measures. See the Company's press release on August 8, 2017 titled, "Diodes Incorporated Reports Second Quarter 2017 Financial Results" for detailed information related to the Company's non-GAAP measures and a reconciliation of GAAP net income to non-GAAP net income.



DISCRETE ANALOG LOGIC MIXED-SIGNAL

Management Representative



Dr. Keh-Shev	w Lu		
President and CE	EO		
Diodes Incorporated Texas Instruments	Since 2005 27 years		
Experience: Senior Vice President of TI Worldwide Analog and Logic President of Texas Instruments – Asia 			

Education:

 Master's Degree and Doctorate in Electrical Engineering Texas Tech University



Bachelor's Degreewww.d.odes.com

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About Diodes Incorporated

A leading global manufacturer and supplier of high-quality application specific, standard products within the broad discrete, logic and analog markets, serving the consumer, computing, communications, Industrial and automotive segments.





Company Overview

Global Operations and World-class Manufacturing & Packaging

- NASDAQ: DIOD
- Founded in 1959
- Headquartered in Plano, TX; 21 locations globally
- Manufacturing in UK, Germany, China and Taiwan
- ISO9001:2008 Certified / TS16949:2009 Certified ISO14001 Certified
- Key acquisitions:
 - Anachip Corporation, Taiwan Jan. 2006
 - Advanced Power Devices Nov. 2006
 - Zetex June 2008
 - Power Analog Microelectronics (PAM) Oct. 2012
 - BCD Semiconductor Mar. 2013
 - Pericom Semiconductor Nov. 2015
- Over 7,692 employees worldwide

26 consecutive years of profitability



Track Record of Consistent Growth

2016: Record Annual Revenue & Gross Profit



GAAP net income was \$15.9 million, or \$0.32 per share; Non-GAAP net income was a \$38.4 million, or \$0.77 per share
 Generated significant cash flow:

\$124.7 million cash flow from operations and \$66.2 million free cash flow

- = \$29.4 million net cash flow, includes pay-down of \$36.4 million of long-term debt and \$18 million for share
 - buyback



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    DISCRETE
    ANALOG
    LOGIC
    MIXED-SIGNAL
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Where We Are Today

Benefiting from Strong Operating Leverage

- Surpassed the \$500 million revenue mark in 1H17
- Positioned to achieve \$1 billion annual revenue goal in 2017
- Successfully integrated Pericom; capitalizing on cross-selling synergies
 - 8" front-end manufacturing capabilities for discrete products
- Favorable growth trends in target end markets: Automotive, Industrial, Comms
 - Advancing toward target business model:
 - 35% gross margin, 20% operating expense, 15% operating margin
 - Forward strategy focused on profitability growth



Business Objective

Then

To consistently achieve above-market profitable growth, utilizing our innovative and

cost-effective packaging and silicon technology, suited for high-volume, high-growth markets by leveraging process expertise and design excellence to deliver high quality semiconductor products.

Now

To focus on: •driving profitability growth •capitalizing on increased operating leverage to generate expanding earnings •cross-selling broad product &

silicon technology portfolio

 improving margins through manufacturing efficiencies



Focusing on High-Volume, High-Growth Applications





Successful Growth in Automotive

- Auto revenue has doubled over last 3 years
 - Leveraging expertise in European auto market
 - Key growth drivers:
 Infotainment
 - Body Control
 - Innovation focused on:
 - Motor Drive
 - LED Lighting
 - Connected Driving

Developing solutions with
 Developing solutions and
 Control of the set o



Portfolio of 1500+ Automotive-Qualified Products Page 28



Complete Platform Solutions: Notebooks



USB Type-C Connector Opportunity



Key Differentiator – Packaging Design



Advanced Packaging

Miniaturization and Multi-Chip Packaging



Efficient Manufacturing + Superior Processes

.





Shanghai-based packaging with capacity over 34 billion units

Chengdu facility has potential capacity 3X of Shanghai

- Additional facilities in Neuhaus, Germany and Chenadu. China



- Wafer Fabs Two fabs in Shanghai (6" and 8"), one discrete fab in Oldham, UK (6")
 - Bipolar, BiCMOS, CMOS & BCD process



60 Economies of Scale: Capacity & Loading Percentage in SAT *CapEx Model = 5% - 9% of Revenue Parts (billions) Non-utilized capatity 40 91% 82% Utilized Capacity (output) 83% 90% 79% 88% 6 6 96% 88% 93% 91% 20 92% 90% 2006 Y 2007 Y 2008 Y 2009 Y 2010 Y 2011 Y 2012 Y 2014 Y 2015 Y 2016 Y 2017 H/Y 2013 Y DISCRETE ANALOG LOGIC MIXED-SIGNAL www.diodes.com

Revenue Profile as of 2Q 2017



In millions, except per share	2Q16	1Q17	2Q17	ΥοΥ
Revenue	\$236.6	\$236.3	\$264.2	11.7%
Gross Profit (GAAP)	\$74.8	\$73.9	\$90.1	20.5%
Gross Profit Margin % (GAAP)	31.6%	31.3%	34.1%	+250bp
Net Income (GAAP)	\$5.8	\$1.2	\$13.2	
Net Income (non-GAAP)	\$9.8	\$7.0	<mark>\$17.8</mark>	
EPS (non-GAAP)	\$0.20	\$0.14	\$0.36	80.0%
Cash Flow from Operations	\$16.4	\$45.6	<mark>\$19.8</mark>	
EBITDA (non-GAAP)	\$36.8	\$28.6	\$45.8	24.5%



DISCRETE ANALOG LOGIC MIXED-SIGNAL

Balance Sheet

In millions	Dec 31, 2015	Dec 31, 2016	June 30, 2017
Cash	\$218	\$248	\$267
Short-term Investments	\$65	\$30	\$16
Inventory	\$203	\$193	\$208
Current Assets	\$751	\$733	\$758
Total Assets	\$1599	\$1531	\$1579
Long-term Debt	\$454	\$413	\$383
Total Liabilities	\$756	\$708	\$712
Total Equity	\$843	\$820	\$867







Global Organization - TS16949 Manufacturing



Diodes' Strategy

Capitalizing on Operating Leverage to Deliver Protitability Growth



EXHIBIT 99.2



Investor Relations Presentation

September 2017

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Potential risks and uncertainties include, but are not limited to, such factors as: the risk that such expectations may not be met: the risk that the expected benefits of acquisitions may not be realized or that integration of acquired businesses, such as Pericom, may not continue as rapidly as we anticipate; the risk that we may not be able to maintain our current growth strategy or continue to maintain our current performance, costs, and loadings in our manufacturing facilities; the risk that we may not be able to increase our automotive or other revenue and market share; risks of domestic and foreign operations, including excessive operation costs, labor shortages, higher tax rates, and our joint venture prospects, the risk that we may not continue our share repurchase program; the risks of cyclical downturns in the semiconductor industry and of change sin end-market demand or product mix that may affect gross margin or render inventory obsolete; the risk of unfavorable currency exchange rates; the risk that our future outlook or guidance may be incorrect; the risks of global economic weakness or instability in global financial markets; the risks of trade restrictions, tariffs, or embargoes; filings with the United States Securities and Exchange Commission.

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Diodes Incorporated	Since 2005
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- Bachelor's Degree in Engineering National Cheng Kung University - Taiwan



A leading global manufacturer and supplier of high-quality **application specific, standard products** within the broad discrete, logic and analog markets, serving the **consumer**, **computing, communications**, **Industrial** and **automotive** segments.





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- 26 consecutive years of profitability





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2016: Record Annual Revenue & Gross Profit



2016 Financial Highlights:

- Revenue increased 11% to \$942.2 million; Gross margin improved 120 basis points to 30.5%
- GAAP net income was \$15.9 million, or \$0.32 per share; Non-GAAP net income was a \$38.4 million, or \$0.77 per share
- Generated significant cash flow:
 - \$124.7 million cash flow from operations and \$66.2 million free cash flow
 - \$29.4 million net cash flow, includes pay-down of \$36.4 million of long-term debt and \$18 million for share buyback



Benefiting from Strong Operating Leverage

- Surpassed the \$500 million revenue mark in 1H17
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 - 35% gross margin, 20% operating expense, 15% operating margin
- Forward strategy focused on profitability growth



Then

To consistently achieve above-market profitable growth,

- utilizing our innovative and
- cost-effective packaging and silicon technology, suited for highvolume, high-growth markets by leveraging process expertise and design excellence to deliver high quality semiconductor products.

Now

To focus on:

- driving profitability growth
- capitalizing on increased operating leverage to generate expanding earnings
- cross-selling broad product & silicon technology portfolio
- improving margins through manufacturing efficiencies



Focusing on High-Volume, High-Growth Applications



Key focus areas:

Consumer

- IoT
- USB Type-C
- Power Devices

Computing

- Cloud & Data Center
- USB Type-C

Communications

- Smartphones
- Quick/Wireless Charging

Industrial

- Motor Drivers
- Power Devices
- LED Lighting

Automotive

- Body Control
- Powertrain
- Lighting





- Auto revenue has doubled over last 3 years
- Leveraging expertise in European auto market
- Key growth drivers:
 - Infotainment
 - Body Control
- Innovation focused on:
 - Motor Drive
 - LED Lighting
 - Connected Driving
 - Developing solutions with top-tier chipset vendors and global OEMs

Complete Platform Solutions: Notebooks

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Growing trend toward USB Type-C connectors driven by Thunderbolt 3 DP ReDriver Rx USB Type _C" standard: TVS Π Crossbar Tx2, Rx2 Switch, Tx-R USB3.1 Gen 2 SBU1.SB Increased data transfer speeds Redrive ReDriver Greater power delivery D+,D-I²C USB Type-C[™] TVS PD Connector USB3.1 GEN -2 Support for video streaming Controller UART USB2 Switch Power TVS Power D+,D-Switch/ FET, D+,D-Charge USB Controller Pow OVP LS / USB PS Graphi DIODES USB Hard Disk Drive USB Po Notebook PC, Tablet, PC, AIO

Key Differentiator – Packaging Design

Focus: Miniaturization and Power Efficiency

Miniaturization and Multi-Chip Packaging

Miniaturization

DDFN0402 the smallest discrete semiconductor package

Multi-Chip Packaging

Dual-Flat No-Lead (DFN) DDFN (Encapsulated CSP) Chip-Scale Package (CSP)

HS IntelliFET: ZXMS3001

Efficient Manufacturing + Superior Processes

Packaging

60

- Shanghai-based packaging with capacity over 34 billion units
- Chengdu facility has potential capacity 3X of Shanghai
- Additional facilities in Neuhaus, Germany and Chengdu, China

Economies of Scale: Capacity & Loading Percentage in SAT

Wafer Fabs

- Two fabs in Shanghai (6" and 8"), one discrete fab in Oldham, UK (6")
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Cash Flow from Operations	\$16.4	\$45.6	\$19.8	
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Total Assets	\$1599	\$1531	\$1579
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Total Liabilities	\$756	\$708	\$712
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- Non-GAAP operating expenses to be 22.5% of revenue, +/- 1%
- Interest expense to be approx \$3.0 million, and tax rate to be 30%, +/- 3%
- Shares used to calculate diluted EPS approx 50.3 million
- Purchase accounting adjustments for Pericom and previous acquisitions of \$3.1 million after tax are not included in non-GAAP estimates

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Global Organization - TS16949 Manufacturing

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